

H Chip Series

USB2.0 High-Speed Bridge Solutions



OVERVIEW

The FTDI H Chip Series is a family of high-speed USB bridge solutions designed to simplify system complexity and reduce the overall component count. The combination of multiple interfaces into one USB connection eliminates the need for additional USB components, streamlining system design and the Bill of Materials (BOM).

Each channel in the FTDI H Chip Series is presented to the host system as a separate device, allowing independent configuration for protocol such as UART, MPSSE, FIFO, and/or GPIO. This flexibility enables application such as four UARTs operating with different baud rates on the same chip. For battery-powered devices, the FT4222H chip includes battery charger detection, supporting higher charging currents (when supported by the USB host) enabling faster battery charging times.

As one of the recognized leaders in the USB-to-digital interface industry, FTDI Chip is known for its reliable, high-performance USB2.0 high-speed bridge products that deliver outstanding quality across a wide range of applications.

***Royalty-free device drivers are available for all major operating systems, including Windows, MacOS, Linux and Android.*

KEY FEATURES

- Single chip USB supports up to 4 ts with a variety of configurations
- Complete USB protocol handled on the chip
- Supports high-speed (480Mbits) and full-speed (12Mbits) compatible
- USB bulk data transfer mode (512byte packets in high-speed mode)
- Single or dual MPSSE to simplify synchronous serial protocol (USB to JTAG, I²C, SPI or bit-bang) design (excluding FT4222H)
- FT232H and FT4222H optimized for open-drain I²C IOs
- Support bus powered and self-powered USB configurations
- Low operating and USB suspend current
- Integrated with power-on-reset circuit
- Configurable SPI and I²C Master/Slave interface controller*
- On-chip OTP memory, stores USB Vendor ID (VID), Product ID (PID), device serial number, product description string and various other vendor specific data*
- Compatible with four I²C speeds: Standard Mode (SM) up to 100Kbit/s, Fast Mode (FM) up to 400Kbit/s, Fast Mode Plus (FM+) up to 1Mbit/s, and High-Speed Mode (HS) up to 3.4Mbit/s*

** Applicable to FT4222H only*

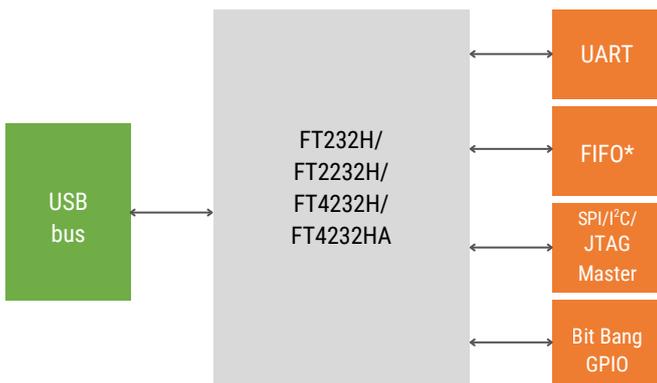


Figure 1: FT232H/FT2232H/FT4232H/FT4232HA block diagram

**FIFO does not apply to FT4232H & FT4232HA*

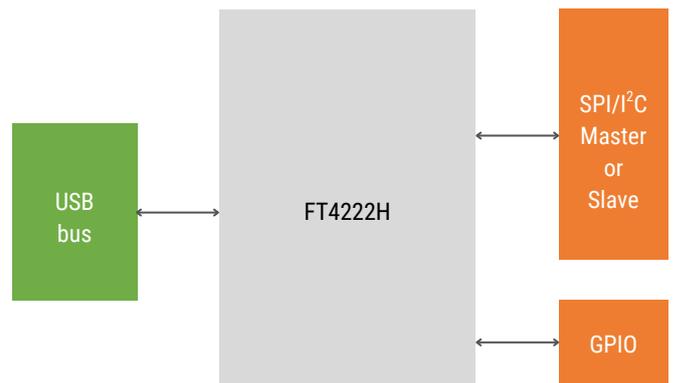


Figure 2: FT4222H block diagram

H CHIP SERIES COMPARISON TABLE

H CHIP SERIES							PACKING INFORMATION			DEVELOPMENT KIT			
PRODUCT CODE	PRODUCT NAME	APPLICATION INTERFACE	CHANNELS	CLOCKING	EEPROM	DATA THROUGHPUT (MAX)	PACKAGE PART NUMBER	PACKAGE	PACKING	PRODUCT CODE	CHANNELS	USB CONNECTOR	I/O CONNECTOR
FT232H	Single Channel High-Speed USB to Multipurpose Interfaces	UART ASYNC FIFO x1 SYNC FIFO x1 MPSSE x1 GPIO x16	1	External (12MHz)	External	12MBaud 8MByte/s 40MByte/s 30Mbit/s	FT232HQ-TRAY	48 QFN	260/tray	UM232H	Single	Mini B	0.6" wide 28 pin DIP
							FT232HQ-REEL		3,000/reel				
FT2232H	Dual Channel High-Speed USB to Multipurpose Interfaces	UART x2 ASYNC FIFO x2 SYNC FIFO x1 MPSSE x2 GPIO x32	2	External (12MHz)	External	12MBaud UART 8MByte/s Async FIFO 40MByte/s Sync FIFO 30Mbit/s MPSSE	FT2232HQ-TRAY	64 QFN	260/tray	FT2232H Mini Module FT2232H-56Q Mini Module	Dual	Mini B Micro B	Two 26-pin, 0.1" dual-row headers
							FT2232HQ-REEL	64 QFN	3,000/reel				
FT4232H	Quad Channel High-Speed USB to Multipurpose Interfaces	UART x4 MPSSE x2 GPIO x32	4	External (12MHz)	External	12MBaud UART 30Mbit/s MPSSE	FT4232HQ-TRAY	64 QFN	260/tray	FT4232H Mini Module FT4232H-56Q Mini Module	Quad	Mini B Micro B	Two 26-pin, 0.1" dual-row headers
							FT4232HQ-REEL	64 QFN	3,000/reel				
FT4232HA	Automotive Grade - Quad Channel High-Speed USB to Multipurpose Interfaces	UART x4 MPSSE x2 GPIO x32	4	External (12MHz)	External	12MBaud 30Mbit/s	FT4232HAQ-TRAY	64 QFN	260/tray	FT4232HA Mini Module	Quad	Mini B	Two 26-pin, 0.1" dual-row headers
							FT4232HAQ-REEL		2,600/reel				
FT4222H	Multi-Channel High-Speed USB to SPI/I ² C Bridge	SPI/ I ² C (MASTER/SLAVE) GPIO	4 Channels SPI Slave Selection	External (12MHz)	Internal OTP	53.8Mbit/s SPI 3.4 Mbit/s I ² C	FT4222HQ-D-TRAY	32 VQFN	490/tray	UMFT4222EV-D	up to 4 (depending on mode)	Micro B	0.8" wide 24 pin DIP
							FT4222HQ-D-REEL		5,000/reel				

TECHNICAL SPECIFICATIONS

- Configurable ACBUS I/O pins (FT232H)
- Low 1.2V or 1.8V chip core
- +3.3 V I/O interfacing (+5 V Tolerant) excluding FT4222H
- UHCI/OHCI/EHCI host controller compatible
- Typical operating current 70mA
- Wide temperature ranges from -40°C to 85°C

FT4232HA

- 1.2 V (chip core)
- +3.3V single supply operating voltage range
- Supports an **extended automotive grade 2** operating temperature range of **-40°C to 105°C**

FT4222H

- 1.8 to 3.3 V I/O interfacing (+5 V Tolerant)
- Configurable I/O pin output drive strength; 4mA (min) and 16mA (max)

TYPICAL APPLICATIONS

- ADAS Systems
- Sensor expansion
- BLE expansion
- EV charger
- T-Box (Telematics Box)
- Data Center Server
- 5G Network
- FPGA Programming
- Server Tooling
- Edge computing
- Game controller
- Monitor
- AI Control

FTDI Chip offers royalty free VCP (Virtual Com Port) and D2XX direct driver for Windows, Linux, Mac and Android (J2xx/D2xx only). Visit <http://ftdichip.com/drivers/> for the full driver support list including OS versions and legacy OS.

For installation guide, please visit our webpage at <https://ftdichip.com/document/installation-guides/> for details on how to install the drivers. Additional installation guides, application notes and technical note are also available.



ABOUT FTDI CHIP

FTDI Chip develops innovative silicon solutions that enhance interaction with the latest global technologies. Our primary objective is to “bridge technologies” to empower engineers with sophisticated, feature-rich, robust and easy-to-use product platforms. These platforms enable creation of high-performance electronic designs with minimal peripheral components, low power consumption, and efficient use of board space.

FTDI Chip’s long-established, continuously expanding Universal Serial Bus (USB) product line features universally recognized brands such as the ubiquitous

R-Chip, X-Chip, Hi-Speed, and SuperSpeed USB 3.0 series.

FTDI Chip is a fabless semiconductor company, partnered with the world’s leading foundries. Our headquarter is in Glasgow, UK and is supported with research and development facilities in Glasgow, and Singapore. We maintain a wide network of sales and technical support in Glasgow, Tigard (Oregon, USA) and Shanghai (China).

For more information go to: www.ftdichip.com

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